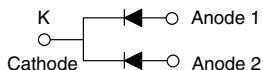


# Hyperfast Rectifier, 2 x 5 A FRED Pt®

## eSMP® Series



SMPC (TO-277A)



## FEATURES

- Hyperfast recovery time, reduced  $Q_{rr}$ , and soft recovery
- 175 °C maximum operating junction temperature
- Specified for output and snubber operation
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
FREE

## LINKS TO ADDITIONAL RESOURCES



3D Models

## PRIMARY CHARACTERISTICS

|                       |                |
|-----------------------|----------------|
| $I_{F(AV)}$           | 2 x 5 A        |
| $V_R$                 | 200 V          |
| $V_F$ at $I_F$        | 0.75 V         |
| $t_{rr}$ (typ.)       | 25 ns          |
| $T_J$ max.            | 175 °C         |
| Package               | SMPC (TO-277A) |
| Circuit configuration | Common cathode |

## DESCRIPTION / APPLICATIONS

State of the art hyper fast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyper fast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in snubber, boost, as high frequency rectifiers and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

## MECHANICAL DATA

**Case:** SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating  
Halogen-free, RoHS-compliant

**Terminals:** matte tin plated leads, solderable per J-STD-002

## ABSOLUTE MAXIMUM RATINGS

| PARAMETER                                   | SYMBOL         | TEST CONDITIONS   | VALUES      | UNITS |
|---------------------------------------------|----------------|-------------------|-------------|-------|
| Peak repetitive reverse voltage             | $V_{RRM}$      |                   | 200         | V     |
| Average rectified forward current           | $I_{F(AV)}$    | $T_{Sp} = 155$ °C | 10          | A     |
| per device                                  |                |                   | 5           |       |
| Non-repetitive peak surge current           | $I_{FSM}$      | $T_J = 25$ °C     | 130         |       |
| per device                                  |                |                   | 70          |       |
| Operating junction and storage temperatures | $T_J, T_{Stg}$ |                   | -55 to +175 | °C    |

## ELECTRICAL SPECIFICATIONS ( $T_J = 25$ °C unless otherwise specified)

| PARAMETER                           | SYMBOL        | TEST CONDITIONS                   | MIN. | TYP. | MAX. | UNITS   |
|-------------------------------------|---------------|-----------------------------------|------|------|------|---------|
| Breakdown voltage, blocking voltage | $V_{BR}, V_R$ | $I_R = 100$ $\mu$ A               | 200  | -    | -    | V       |
| Forward voltage, per diode          | $V_F$         | $I_F = 5$ A                       | -    | 0.92 | 0.98 |         |
|                                     |               | $I_F = 5$ A, $T_J = 150$ °C       | -    | 0.75 | 0.82 |         |
| Reverse leakage current, per diode  | $I_R$         | $V_R = V_R$ rated                 | -    | -    | 2    | $\mu$ A |
|                                     |               | $T_J = 150$ °C, $V_R = V_R$ rated | -    | 6    | 80   |         |
| Junction capacitance                | $C_T$         | $V_R = 200$ V                     | -    | 17   | -    | pF      |

| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise specified) |           |                                                                                |      |      |      |       |
|----------------------------------------------------------------------------------------------------------|-----------|--------------------------------------------------------------------------------|------|------|------|-------|
| PARAMETER                                                                                                | SYMBOL    | TEST CONDITIONS                                                                | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time                                                                                    | $t_{rr}$  | $I_F = 1\text{ A}$ , $dI_F/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$ | -    | 25   | -    | ns    |
|                                                                                                          |           | $I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$           | -    | -    | 25   |       |
|                                                                                                          |           | $T_J = 25\text{ }^{\circ}\text{C}$                                             | -    | 18   | -    |       |
|                                                                                                          |           | $T_J = 125\text{ }^{\circ}\text{C}$                                            | -    | 28   | -    |       |
| Peak recovery current                                                                                    | $I_{RRM}$ | $T_J = 25\text{ }^{\circ}\text{C}$                                             | -    | 2    | -    | A     |
|                                                                                                          |           | $T_J = 125\text{ }^{\circ}\text{C}$                                            | -    | 3.8  | -    |       |
| Reverse recovery charge                                                                                  | $Q_{rr}$  | $T_J = 25\text{ }^{\circ}\text{C}$                                             | -    | 18   | -    | nC    |
|                                                                                                          |           | $T_J = 125\text{ }^{\circ}\text{C}$                                            | -    | 53   | -    |       |

| <b>THERMAL - MECHANICAL SPECIFICATIONS</b>       |                   |                           |        |      |      |                             |
|--------------------------------------------------|-------------------|---------------------------|--------|------|------|-----------------------------|
| PARAMETER                                        | SYMBOL            | TEST CONDITIONS           | MIN.   | TYP. | MAX. | UNITS                       |
| Maximum junction and storage temperature range   | $T_J$ , $T_{Stg}$ |                           | -55    | -    | 175  | $^{\circ}\text{C}$          |
| Thermal resistance, junction to mount, per leg   | $R_{thJM}$        |                           | -      | 2.5  | 3.5  | $^{\circ}\text{C}/\text{W}$ |
| Thermal resistance, junction to ambient, per leg | $R_{thJA}$        |                           | -      | 80   | -    | $^{\circ}\text{C}/\text{W}$ |
| Approximate weight                               |                   |                           | 0.1    |      |      | g                           |
|                                                  |                   |                           | 0.0035 |      |      | oz.                         |
| Marking device                                   |                   | Case style SMPC (TO-277A) | SCH2   |      |      |                             |

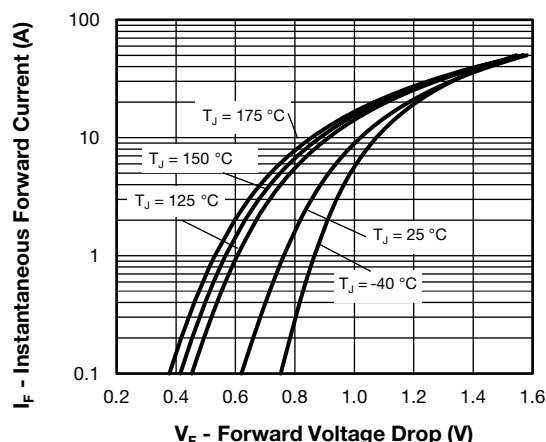


Fig. 1 - Typical Forward Voltage Drop Characteristics

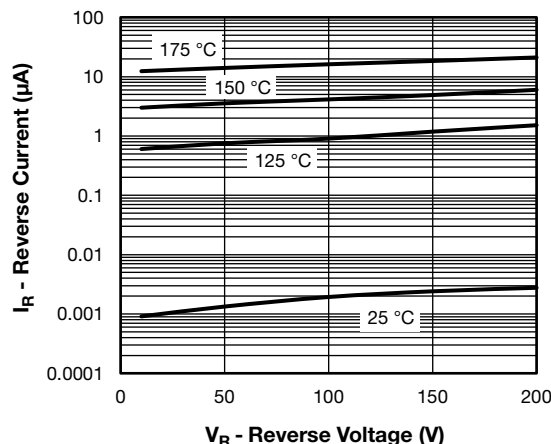


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

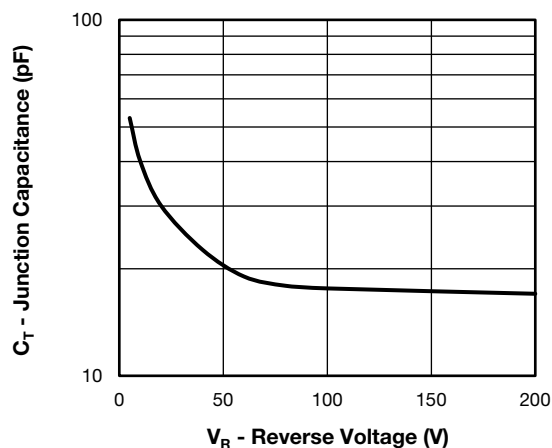


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

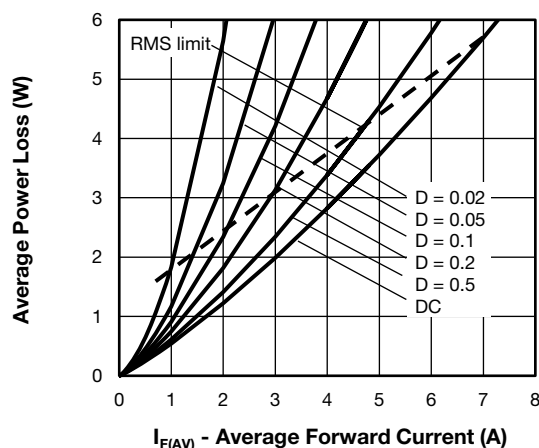


Fig. 5 - Forward Power Loss Characteristics

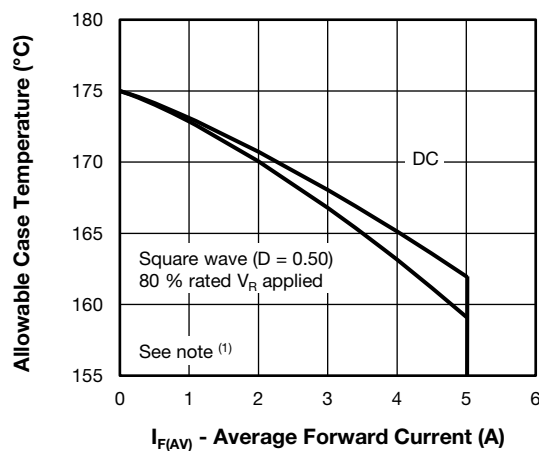
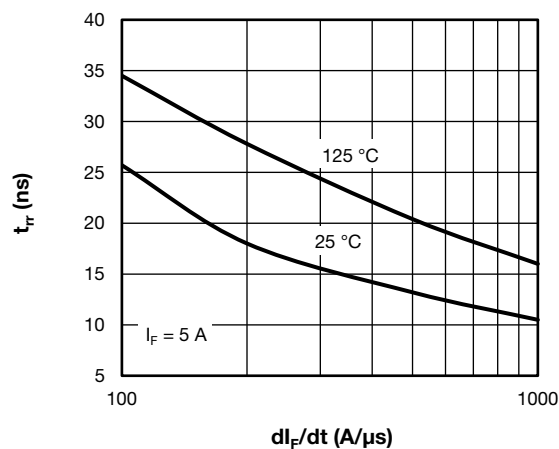
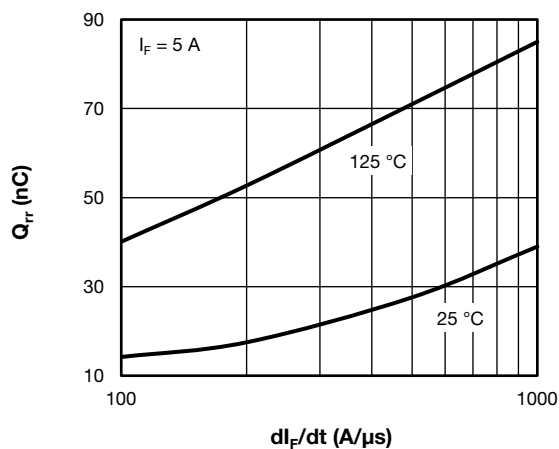


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current


Fig. 6 - Typical Reverse Recovery Time vs.  $dI_F/dt$ 

Fig. 7 - Typical Stored Charge vs.  $dI_F/dt$ 

#### Note

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 5);  
 $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = rated  $V_R$

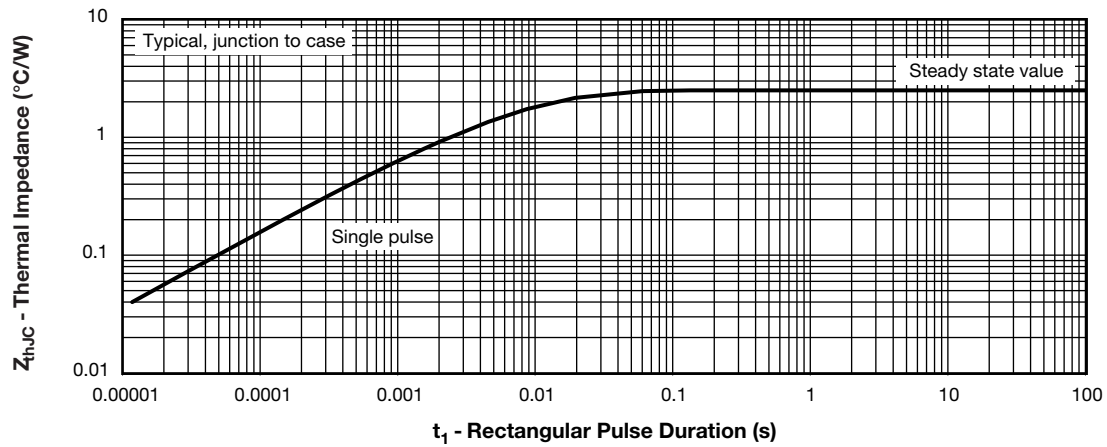


Fig. 8 - Typical Transient Thermal Impedance, Junction to Case

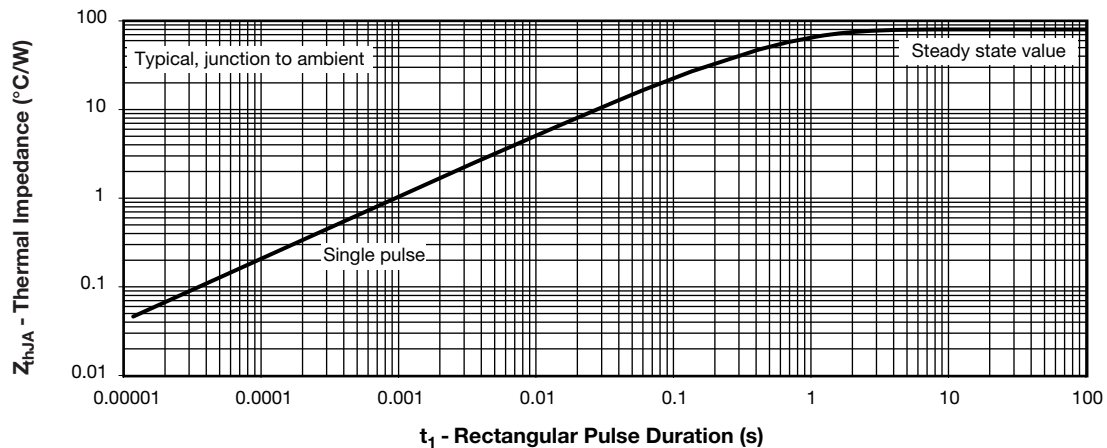


Fig. 9 - Typical Transient Thermal Impedance, Junction to Ambient

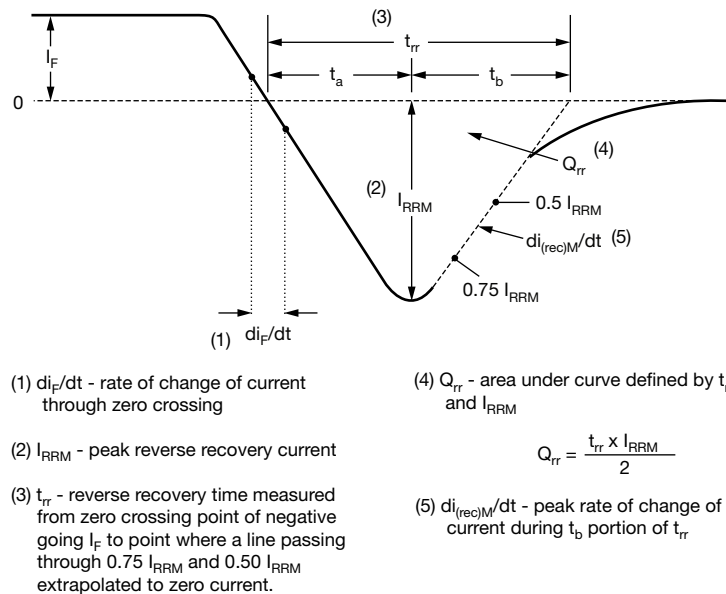


Fig. 10 - Reverse Recovery Waveform and Definitions



## ORDERING INFORMATION TABLE

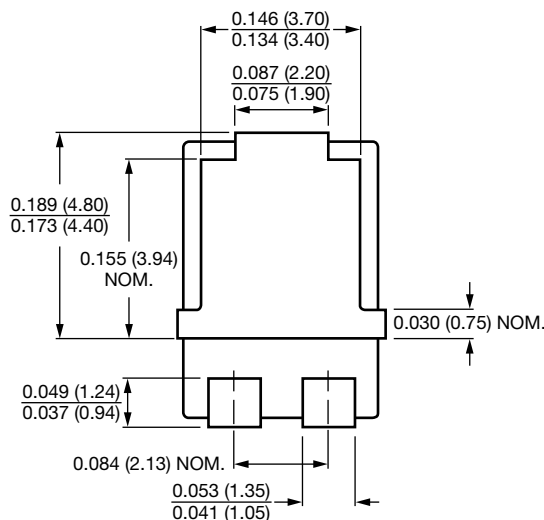
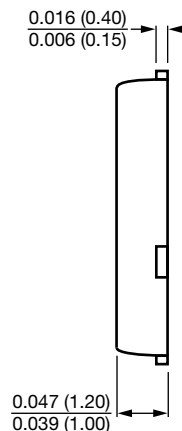
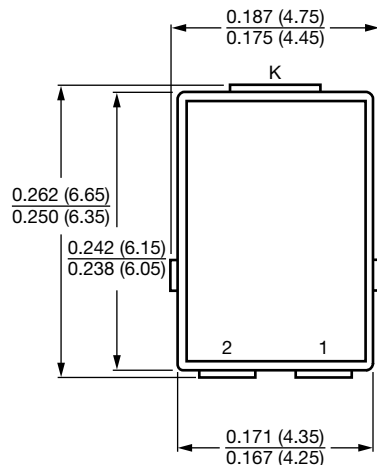
|             |                                                                       |    |   |   |   |    |     |
|-------------|-----------------------------------------------------------------------|----|---|---|---|----|-----|
| Device code | VS-                                                                   | 10 | C | S | H | 02 | -M3 |
|             | 1                                                                     | 2  | 3 | 4 | 5 | 6  | 7   |
| 1           | - Vishay Semiconductors product                                       |    |   |   |   |    |     |
| 2           | - Current rating (10 = 10 A)                                          |    |   |   |   |    |     |
| 3           | - Circuit configuration:<br>C = common cathode                        |    |   |   |   |    |     |
| 4           | - S = SMPC package                                                    |    |   |   |   |    |     |
| 5           | - Process type,<br>H = hyper fast recovery                            |    |   |   |   |    |     |
| 6           | - Voltage code (02 = 200 V)                                           |    |   |   |   |    |     |
| 7           | - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free |    |   |   |   |    |     |

| ORDERING INFORMATION (Example) |                   |                        |                                    |
|--------------------------------|-------------------|------------------------|------------------------------------|
| PREFERRED P/N                  | QUANTITY PER REEL | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION              |
| VS-10CSH02-M3/86A              | 1500              | 1500                   | 7" diameter plastic tape and reel  |
| VS-10CSH02-M3/87A              | 6500              | 6500                   | 13" diameter plastic tape and reel |

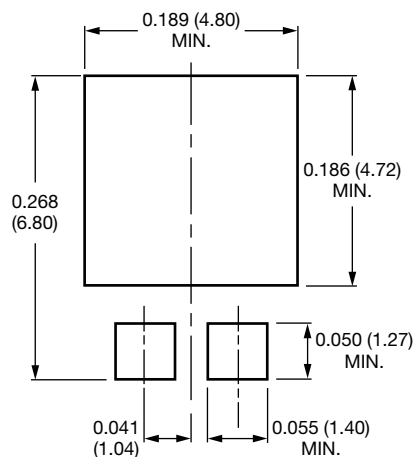
| LINKS TO RELATED DOCUMENTS |                                                                        |
|----------------------------|------------------------------------------------------------------------|
| Dimensions                 | <a href="http://www.vishay.com/doc?95570">www.vishay.com/doc?95570</a> |
| Part marking information   | <a href="http://www.vishay.com/doc?95565">www.vishay.com/doc?95565</a> |
| Packaging information      | <a href="http://www.vishay.com/doc?88869">www.vishay.com/doc?88869</a> |
| SPICE model                | <a href="http://www.vishay.com/doc?96095">www.vishay.com/doc?96095</a> |

## SMPC (TO-277A)

**DIMENSIONS** in inches (millimeters)



### Mounting Pad Layout



Conform to JEDEC® TO-277A



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